# 2SB0930 (2SB930), 2SB0930A (2SB930A)

## Silicon PNP epitaxial planar type

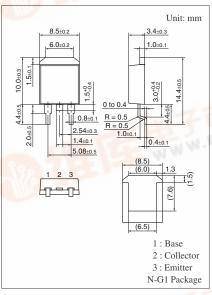
For power amplification
Complementary to 2SD1253, 2SD1253A

#### ■ Features

- High forward current transfer ratio h<sub>FE</sub> which has satisfactory linearity
- Low collector-emitter saturation voltage V<sub>CE(sat)</sub>
- N type package enabling direct soldering of the radiating fin to the printed circuit board, etc. of small electronic equipment.

### ■ Absolute Maximum Ratings $T_C = 25$ °C

Parameter	Symbol	Rating	Unit		
Collector-base voltage	2SB0930	V <sub>CBO</sub>	-60	V	
(Emitter open)	2SB0930A		-80		
Collector-emitter voltage	2SB0930	V <sub>CEO</sub>	-60	V	
(Base open)	2SB0930A		-80		
Emitter-base voltage (Coll	$V_{\rm EBO}$	-5	V		
Collector current	$I_C$	-4	A		
Peak collector current	$I_{CP}$	-8	A		
Collector power dissipation	P <sub>C</sub>	40	W		
	$T_a = 25$ °C		1.3		
Junction temperature		T <sub>j</sub>	150	°C	
Storage temperature		$T_{stg}$	-55 to +150	°C	



Note) Self-supported type package is also prepared.

### ■ Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

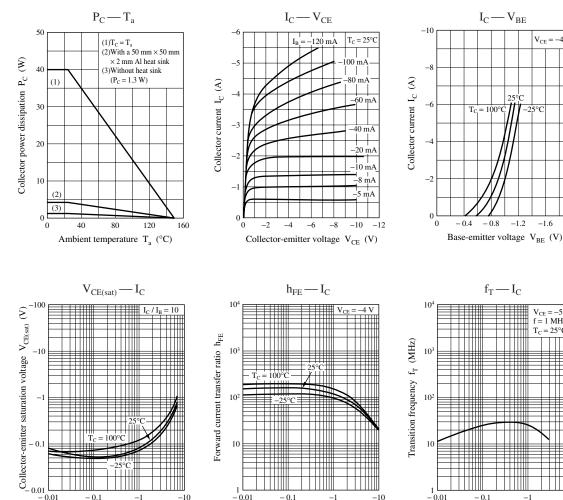
Parameter	1	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage	2SB0930	V <sub>CEO</sub>	$I_C = -30 \text{ mA}, I_B = 0$	-60			V
(Base open)	2SB0930A			-80			
Collector-emitter cutoff	2SB0930	I <sub>CES</sub>	$V_{CE} = -60 \text{ V}, V_{BE} = 0$			-400	μΑ
current (E-B short)	2SB0930A		$V_{CE} = -80 \text{ V}, V_{BE} = 0$			-400	-17
Collector-emitter cutoff	2SB0930	$I_{CEO}$	$V_{CE} = -30 \text{ V}, I_B = 0$			-700	μΑ
current (Base open)	2SB0930A		$V_{CE} = -60 \text{ V}, I_B = 0$			-700	Mari
Emitter-base cutoff current (Collector open)		$I_{EBO}$	$V_{EB} = -5 \text{ V}, I_C = 0$			-1	mA
Forward current transfer ratio		h <sub>FE1</sub> *	$V_{CE} = -4 \text{ V}, I_{C} = -1 \text{ A}$	70		250	_
		h <sub>FE2</sub>	$V_{CE} = -4 \text{ V}, I_{C} = -3 \text{ A}$	15			
Base-emitter voltage		V <sub>BE</sub>	$V_{CE} = -4 \text{ V}, I_{C} = -3 \text{ A}$			-2.0	V
Collector-emitter saturation	voltage	V <sub>CE(sat)</sub>	$I_C = -4 \text{ A}, I_B = -0.4 \text{ A}$			-1.5	V
Transition frequency		$f_T$	$V_{CE} = -10 \text{ V}, I_{C} = -0.5 \text{ A}, f = 10 \text{ MHz}$		20		MHz
Turn-on time		t <sub>on</sub>	$I_C = -4 A$ ,		0.2		μs
Storage time		t <sub>stg</sub>	$I_{B1} = -0.4 \text{ A}, I_{B2} = 0.4 \text{ A}$		0.5		μs
Fall time		$t_{\rm f}$	$V_{CC} = -50 \text{ V}$		0.2		μs

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

C.CO<sub>HEL</sub> 70 to 150 120 to 250

 $V_{CE} = -4 \text{ V}$ 

 $I_C - V_{BE}$ 

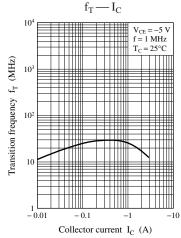


10

-0.01

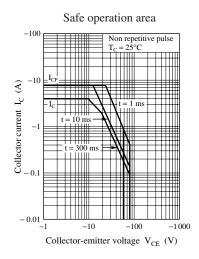
-0.1

Collector current  $I_C$  (A)



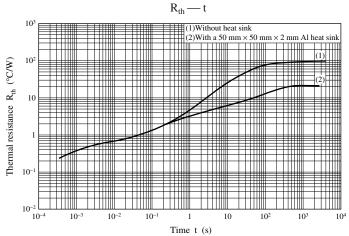
-0.8

-1.2



Collector current I<sub>C</sub> (A)

0.01



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